Attorney Docket No.: 085027-0104 **PATENT**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of Customer Number: 89518

LIN, Mou-Shiung Confirmation Number: 8665

Application No.: 10/755,042 Group Art Unit: 2815

Filed: January 9, 2004 Examiner: JACKSON JR., Jerome

For: INTEGRATED CHIP PACKAGE STRUCTURE USING SILICON SUBSTRATE AND

METHOD OF MANUFACTURING THE SAME

RESPONSE/AMENDMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 CERTIFICATE OF ELECTRONIC TRANSMISSION I hereby certify that this correspondence is being electronically-transmitted to the

United States Patent and Trademark Office on December 13, 2010 /Nicole San Nicolas/

Nicole San Nicolas

Sir:

It is respectfully requested that the time for response to the Office Action dated August 12, 2010, be extended for one month to Monday, December 13, 2010. Please charge the extension fee of \$130.00 to Deposit Account No. 502624. Please charge any additional fees or credit any overpayment to Deposit Account No. 502624.

In response to the Office Action dated August 12, 2010, please amend the aboveidentified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 9 of this paper.

An **Appendix** is attached after the last page, which shows the status of related cases.